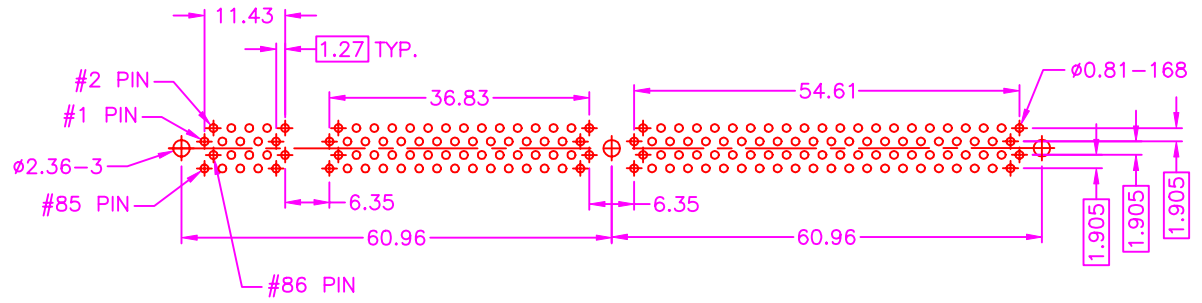
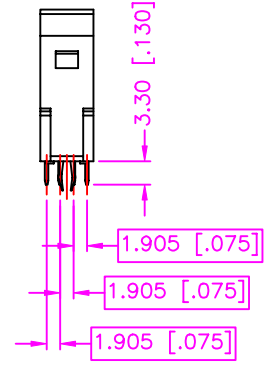
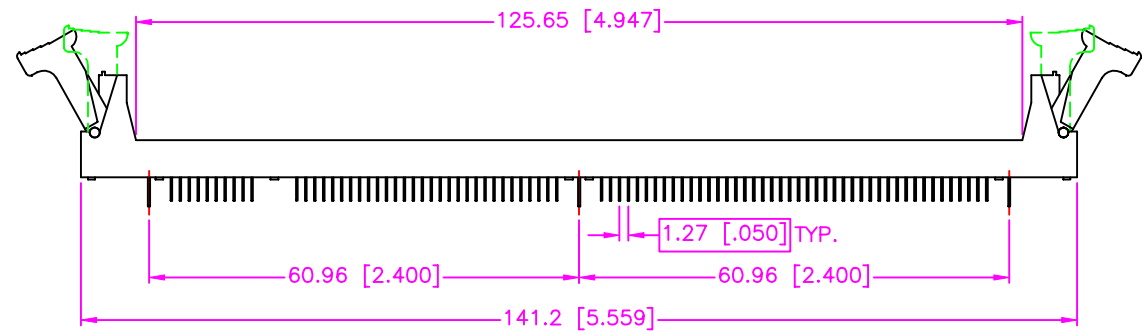
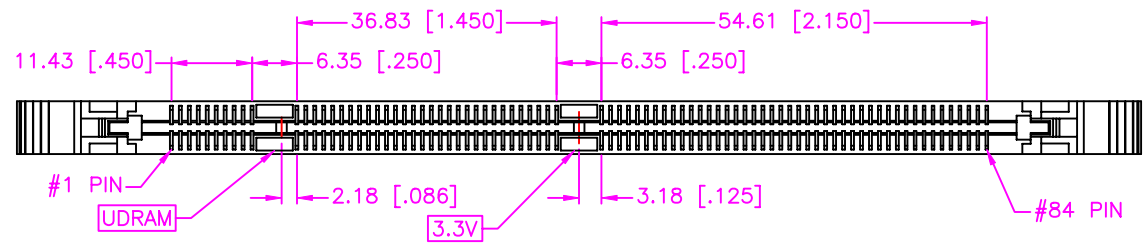


REV.	DESCRIPTION	DATE
—	RELEASE	Apr. 12, 2001
1	BOARDLOCK MODIFY	Jun. 6, 2001
2	MATERIAL MODIFY	Jun. 7, 2001



RECOMMEND P.C.B. LAYOUT
BOTTOM VIEW

MATERIALS

1. HOUSING : THERMOPLASTIC (UL 94V-0), BLACK.
2. LATCH : POLYAMIDE (UL 94V-0), WHITE.
3. TERMINAL : COPPER ALLOY. (t=0.25mm)
4. BOARDLOCK : COPPER ALLOY, NICKEL PLATING. (t=0.30mm)

SPECIFICATION

1. CURRENT RATING : 1 AMP. MAX.
2. DIELECTRIC WITHSTANDING VOLTAGE : 500V AC R.M.S. FOR ONE MINUTE.
3. INSULATION RESISTANCE : 1000M OHMS MIN. AT 500V DC.
4. CONTACT RESISTANCE : 30m OHMS MAX.
5. OPERATING TEMPERATURE : -40°C TO +85°C.

ORDER INFORMATION

38 - 01 02 - 168 - * T - 2

SERIES CODE — TIN PLATING ON SOLDER TAIL

3.3V UDRAM, HIGH LATCH, — CONTACT PLATING OPTIONS

ACD TYPE —

NUMBER OF POSITIONS —

1 : GOLD FLASH
2 : .000010" GOLD
3 : .000015" GOLD
5 : .000030" GOLD

TOLERANCE .0=±.30 [.012] .00=±.20[.008] .000=±.XXX .0000=±. ANG.=±3°		DRAWER <i>ms</i>	 ASTRON TECHNOLOGY CORP.
UNITS : mm [inch]		CHECK <i>Katherlin</i>	
SCALE NONE	SIZE A4	APP'D <i>WJPEZY</i>	DRAW NO. C238-0102
SHEET 1 OF 1		REV. C	10018